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Switch-mode Power Rectifier

Features and Benefits

- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capacity
- 150°C Operating Junction Temperature
- 25 A Total (12.5 A Per Diode Leg)
- This Device is Pb-Free and is RoHS Compliant*

Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

Mechanical Characteristics

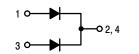
- Case: Epoxy, Molded
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperatures for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Rating: Human Body Model 3B Machine Model C

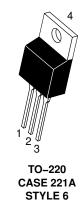


ON Semiconductor®

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SCHOTTKY BARRIER RECTIFIER 25 AMPERES, 35 VOLTS





MARKING DIAGRAM



A= Assembly LocationY= YearWW= Work WeekB2535L = Device CodeG= Pb-Free PackageAKA= Polarity Designator

ORDERING INFORMATION

| | Device | Package | Shipping |
|----|-----------|---------------------|---------------|
| MB | R2535CTLG | TO–220 (Pb–Free) | 50 Units/Rail |

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS (Per Leg)

| Rating | Symbol | Value | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 35 | V |
| Average Rectified Forward Current $(T_C = 142^{\circ}C \text{ per Diode})$ $(T_C = 142^{\circ}C \text{ per Device})$ | I _{F(AV)} | 12.5 25 | A |
| Peak Repetitive Forward Current, per Leg (Sq Wave, 20 kHz, $T_C = 139^{\circ}C$) | I _{FRM} | 25 | Α |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz) | I _{FSM} | 150 | A |
| Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz) | I _{RRM} | 1.0 | Α |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Operating Junction Temperature (Note 1) | TJ | -65 to +150 | °C |
| Voltage Rate of Change (Rated V _R) | dv/dt | 10,000 | V/µs |
| Controlled Avalanche Energy | Waval | 20 | mJ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

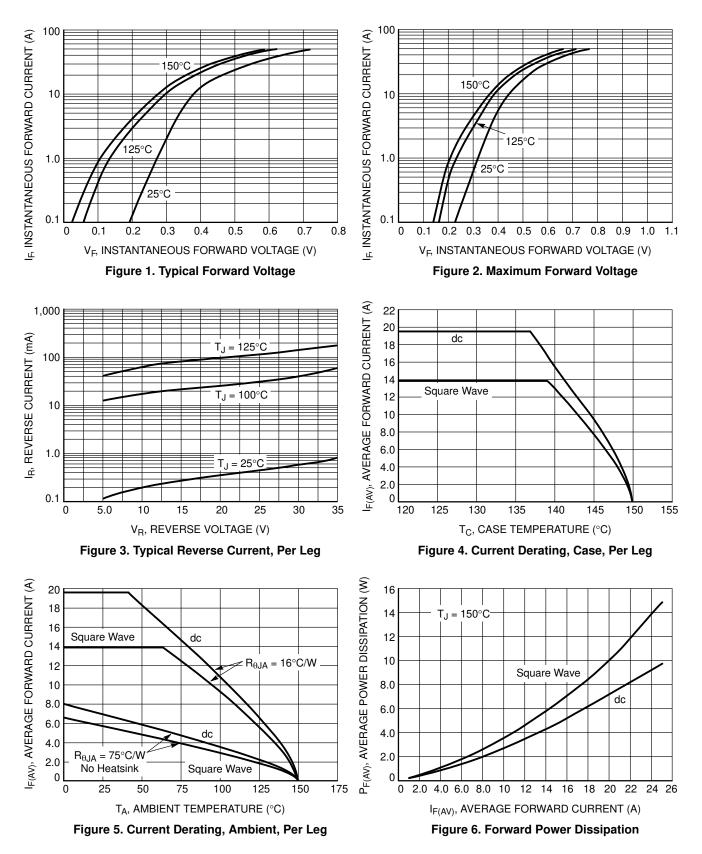
THERMAL CHARACTERISTICS

| Characteristic | Conditions | Symbol | Max | Unit |
|---|------------|-----------------------|------|------|
| Maximum Thermal Resistance, Junction-to-Case | Min. Pad | $R_{	extsf{	heta}JC}$ | 2.0 | °C/W |
| Maximum Thermal Resistance, Junction-to-Ambient | Min. Pad | R_{\thetaJA} | 75.0 | |

ELECTRICAL CHARACTERISTICS

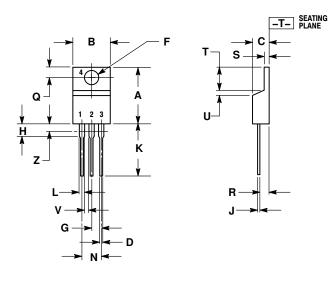
| Characteristic | Symbol | Min | Typical | Max | Unit |
|---|--------|-------------|----------------------|----------------------|------|
| Instantaneous Forward Voltage (Note 2) ($i_F = 25 \text{ Amps}$, $T_j = 25^{\circ}\text{C}$) ($i_F = 12.5 \text{ Amps}$, $Tj = 25^{\circ}\text{C}$) ($i_F = 12.5 \text{ Amps}$, $Tj = 125^{\circ}\text{C}$) | VF | - - - | 0.51 0.41 0.33 | 0.55 0.47 0.41 | V |
| Instantaneous Reverse Current (Note 2) (Rated dc Voltage, Tj = 25°C) (Rated dc Voltage, Tj = 125°C) | İR | | 0.8 300 | 5.0 500 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.



PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED. 3

| | INCHES | | MILLIMETERS | | |
|-----|--------|-------|-------------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 0.570 | 0.620 | 14.48 | 15.75 | |
| В | 0.380 | 0.415 | 9.66 | 10.53 | |
| С | 0.160 | 0.190 | 4.07 | 4.83 | |
| D | 0.025 | 0.038 | 0.64 | 0.96 | |
| F | 0.142 | 0.161 | 3.61 | 4.09 | |
| G | 0.095 | 0.105 | 2.42 | 2.66 | |
| Н | 0.110 | 0.161 | 2.80 | 4.10 | |
| J | 0.014 | 0.024 | 0.36 | 0.61 | |
| κ | 0.500 | 0.562 | 12.70 | 14.27 | |
| L | 0.045 | 0.060 | 1.15 | 1.52 | |
| Ν | 0.190 | 0.210 | 4.83 | 5.33 | |
| Q | 0.100 | 0.120 | 2.54 | 3.04 | |
| R | 0.080 | 0.110 | 2.04 | 2.79 | |
| S | 0.045 | 0.055 | 1.15 | 1.39 | |
| Т | 0.235 | 0.255 | 5.97 | 6.47 | |
| U | 0.000 | 0.050 | 0.00 | 1.27 | |
| ۷ | 0.045 | | 1.15 | | |
| Ζ | | 0.080 | | 2.04 | |

STYLE 6: PIN 1. ANODE CATHODE 2. 3. ANODE 4 CATHODE

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